PD-90396H

International **tor** Rectifier

POWER MOSFET THRU-HOLE (MO-036AB)

Product Summary

Part Number	RDS(on)	ID
IRFG110	0.7 Ω	1.0A

HEXFET[®] MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

IRFG110 JANTX2N7334 JANTXV2N7334 REF:MIL-PRF-19500/597 100V, QUAD N-CHANNEL HEXFET[®] MOSFET TECHNOLOGY



Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Dynamic dv/dt Rating
- Light-weight

	- 3-			
	Parameter		Units	
ID @ VGS = 10V, TC = 25°C	Continuous Drain Current	1.0		
ID @ VGS = 10V, TC = 100°C	Continuous Drain Current	0.6	A	
IDM	Pulsed Drain Current ①	4.0	1	
P _D @ T _C = 25°C	Max. Power Dissipation	1.4	W	
	Linear Derating Factor	0.011	W/°C	
VGS	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy 2	75	mJ	
IAR	Avalanche Current ①	1.0	A	
EAR	Repetitive Avalanche Energy ①	0.14	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	5.5	V/ns	
TJ Operating Junction		-55 to 150	_	
TSTG Storage Temperature Range			°C	
	Lead Temperature	300 (0.63 in./1.6 mm from case for 10s)		
	Weight	1.3 (Typical)	g	

Absolute Maximum Ratings

For footnotes refer to the last page

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	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	100	-	—	V	$V_{GS} = 0V, I_{D} = 1.0mA$
∆BV _{DSS} /∆TJ	Temperature Coefficient of Breakdown Voltage	_	0.13	—	V/°C	Reference to 25° C, I _D = 1.0mA
RDS(on)	Static Drain-to-Source On-State		—	0.7	0	VGS = 10V, ID = 0.6A (4)
	Resistance	—	-	0.8	22	V _{GS} = 10V, I _D = 1.0A
VGS(th)	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
9fs	Forward Transconductance	0.86	-	—	S	V _{DS} > 15V, I _{DS} = 0.6A ④
IDSS	Zero Gate Voltage Drain Current	—	—	25		VDS= 80V ,VGS=0V
		—	-	250	μΛ	$V_{DS} = 80V,$
						$V_{GS} = 0V, T_{J} = 125^{\circ}C$
IGSS	Gate-to-Source Leakage Forward	—	-	100	n A	$V_{GS} = 20V$
IGSS	Gate-to-Source Leakage Reverse	—	-	-100		VGS = -20V
Qg	Total Gate Charge	—	—	15		V _{GS} =10V, I _D = 1.0A
Qgs	Gate-to-Source Charge	—	—	7.5	nC	$V_{DS} = 50V$
Q _{gd}	Gate-to-Drain ('Miller') Charge	—	—	7.5		
^t d(on)	Turn-On Delay Time	—	-	20		$V_{DD} = 50V, I_D = 1.0A,$
tr	Rise Time	—	—	25		V_{GS} =10V, R_{G} = 7.5 Ω
^t d(off)	Turn-Off Delay Time	—	-	40	115	
tf	Fall Time	—	—	40	1	
L _S + L _D	Total Inductance	_	10		nH	Measured from drain lead (6mm/ 0.25in. from package) to source lead (6mm/0.25in. from package)
C _{iss}	Input Capacitance	_	180	_		$V_{GS} = 0V, V_{DS} = 25V$
C _{oss}	Output Capacitance	_	82	_	pF	f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	_	15	_		

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

Source-Drain Diode Ratings and Characteristics

	Parameter		Min	Тур	Мах	Units	Test Conditions
IS	Continuous Source Current	(Body Diode)	_	—	1.0	^	
ISM	Pulse Source Current (Body	/ Diode) ①	—	—	4.0	A	
VSD	Diode Forward Voltage		—	—	1.5	V	$T_j = 25^{\circ}C$, $I_S = 1.0A$, $V_{GS} = 0V$ (4)
trr	Reverse Recovery Time		—		200	ns	Tj = 25°C, IF = 1.0A, di/dt ≤ 100A/μs
QRR	R Reverse Recovery Charge		-	—	0.83	μC	$V_{DD} \leq 30V @$
ton	Forward Turn-On Time	Intrinsic tum-on time is negligible. Turn-on speed is substantially controlled by $L_S + L_D$.					

Thermal Resistance

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction-to-Case	—	_	17	°C/M	
R _{th} JA	Junction-to-Ambient	—	—	90	0/00	Typical socket mount

Note: Corresponding Spice and Saber models are available on International Rectifier Website.

For footnotes refer to the last page

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Fig 1. Typical Output Characteristics



Fig 2. Typical Output Characteristics



Fig 3. Typical Transfer Characteristics



Fig 4. Normalized On-Resistance Vs. Temperature

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Fig 7. Typical Source-Drain Diode Forward Voltage

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Fig 8. Maximum Safe Operating Area

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Fig 10b. Switching Time Waveforms



Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



Fig 12a. Unclamped Inductive Test Circuit



Fig 12b. Unclamped Inductive Waveforms



Fig 13a. Basic Gate Charge Waveform



Fig 12c. Maximum Avalanche Energy Vs. Drain Current



Fig 13b. Gate Charge Test Circuit

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Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $@~V_{DD}$ = 25V, starting TJ = 25°C, L= 150mH Peak IL = 1.0A, VGS = 10V
- 3 ISD \leq 1.0A, di/dt \leq 75A/ μ s,
- $V_{DD} \le 100V$, $T_J \le 150^{\circ}C$
- (4) Pulse width \leq 300 $\mu s;$ Duty Cycle \leq 2%

Case Outline and Dimensions — MO-036AB





NOTES:

- 1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MO-036AB.
- (5) MEASURED WITH THE LEADS CONSTRAINED TO BE PERPENDICULAR TO DATUM PLANE C.

LEAD ASSIGNMENTS





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